ESP32-SOLO-1C

Datasheet



About This Document

This document provides the specifications for the ESP32-SOLO-1C module.

Revision History

For revision history of this document, please refer to the last page.

Documentation Change Notification

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1. Overview

ESP32-SOLO-1C is a powerful, generic Wi-Fi+BT+BLE MCU module that targets a wide variety of applications, ranging from low-power sensor networks to the most demanding tasks, such as voice encoding, music streaming and MP3 decoding.

At the core of this module is the ESP32-D0WD chip. ESP32-D0WD is a member of the ESP32 family of chips, which features a single core and contains all the peripherals of its dual-core counterparts. Available in a 5x5 mm QFN, ESP32-S0WD offers great value for money, with its sustained performance when powering complex IoT applications.

Note:

* For details on the part numbers of the ESP32 family of chips, please refer to the document ESP32 Datasheet.

The integration of Bluetooth, Bluetooth LE and Wi-Fi ensures that a wide range of applications can be targeted, and that the module is all-around: using Wi-Fi allows a large physical range and direct connection to the internet through a Wi-Fi router, while using Bluetooth allows the user to conveniently connect to the phone or broadcast low energy beacons for its detection. The sleep current of the ESP32 chip is less than 5 μ A, making it suitable for battery powered and wearable electronics applications. ESP32 supports a data rate of up to 150 Mbps, and 20 dBm output power at the antenna to ensure the widest physical range. Several peripherals facilitate integration with other electronic devices. As such the chip does offer industry-leading specifications and ultra-high performance for electronic integration, range, power consumption, and connectivity.

The operating system chosen for ESP32 is freeRTOS with LwIP; TLS 1.2 with hardware acceleration is built in as well. Secure (encrypted) over the air (OTA) upgrade is also supported, so that developers can upgrade their products even after their release at minimum cost and effort.

Table 1 provides the specifications of ESP32-SOLO-1C.

Table 1: ESP32-SOLO-1C Specifications

Categories	Items	Specifications			
		802.11 b/g/n (802.11n up to 150 Mbps)			
Wi-Fi	Protocols	A-MPDU and A-MSDU aggregation and 0.4 μ s guard			
VVI-1 1		interval support			
	Frequency range	2.4 GHz ~ 2.5 GHz			
	Protocols	Bluetooth v4.2 BR/EDR and BLE specification			
		NZIF receiver with -97 dBm sensitivity			
Bluetooth	Radio				
		AFH			
	Audio	CVSD and SBC			
		SD card, UART, SPI, SDIO, I2C, LED PWM, Motor			
Hardware	Module interface	PWM, I ² S, IR, pulse counter, GPIO, capacitive touch			
		sensor, ADC, DAC			
	On-chip sensor	Hall sensor			
	On-board clock	40 MHz crystal			
	Operating voltage/Power supply	2.7 V ~ 3.6 V			
	Operating current	Average: 80 mA			

Categories	Items	Specifications
	Minimum current delivered by power supply	500 mA
	Recommended operating temperature range	-40 °C ~ +85 °C
	Package size (mm)	(18.00±0.10) x (25.50±0.10) x (3.10±0.10)



2. Pin Definitions

2.1 Pin Layout

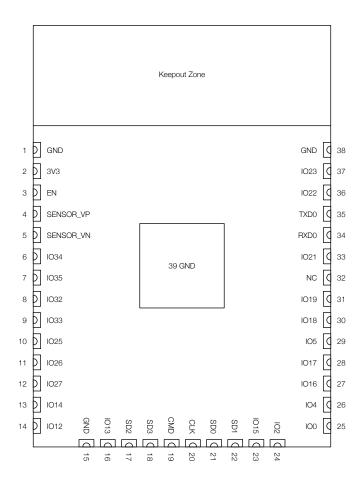


Figure 1: ESP32-SOLO-1C Pin Layout (Top View)

2.2 Pin Description

ESP32-SOLO-1C has 38 pins. See pin definitions in Table 2.

Table 2: Pin Definitions

Name	No.	Туре	Function		
GND 1 F		Р	Ground		
3V3	2	Р	Power supply		
EN	3	1	Module-enable signal. Active high.		
SENSOR_VP 4		1	GPIO36, ADC1_CH0, RTC_GPIO0		
SENSOR_VN 5 I		1	GPIO39, ADC1_CH3, RTC_GPIO3		
IO34 6 I		1	GPIO34, ADC1_CH6, RTC_GPIO4		
1035 7 I		1	GPIO35, ADC1_CH7, RTC_GPIO5		
IO32	8	I/O	GPIO32, XTAL_32K_P (32.768 kHz crystal oscillator input), ADC1_CH4,		
1032 6 1/0		1/0	TOUCH9, RTC_GPIO9		
IO33	9	9 1/0	GPIO33, XTAL_32K_N (32.768 kHz crystal oscillator output), ADC1_CH5,		
1000		1/ 0	TOUCH8, RTC_GPIO8		

Name	No.	Type	Function			
IO25	10	I/O	GPIO25, DAC_1, ADC2_CH8, RTC_GPIO6, EMAC_RXD0			
IO26	11	I/O	GPIO26, DAC_2, ADC2_CH9, RTC_GPIO7, EMAC_RXD1			
IO27	12	I/O	GPIO27, ADC2_CH7, TOUCH7, RTC_GPIO17, EMAC_RX_DV			
IO14 13 I/O		I/O	GPIO14, ADC2_CH6, TOUCH6, RTC_GPIO16, MTMS, HSPICLK, HS2_CLK, SD_CLK, EMAC_TXD2			
IO12	IO12 14 I/O		GPIO12, ADC2_CH5, TOUCH5, RTC_GPIO15, MTDI, HSPIQ, HS2_DATA2, SD_DATA2, EMAC_TXD3			
GND	15	Р	Ground			
IO13	16	I/O	GPIO13, ADC2_CH4, TOUCH4, RTC_GPIO14, MTCK, HSPID, HS2_DATA3, SD_DATA3, EMAC_RX_ER			
SHD/SD2*	17	I/O	GPIO9, SD_DATA2, SPIHD, HS1_DATA2, U1RXD			
SWP/SD3*	18	I/O	GPIO10, SD_DATA3, SPIWP, HS1_DATA3, U1TXD			
SCS/CMD*	19	I/O	GPIO11, SD_CMD, SPICS0, HS1_CMD, U1RTS			
SCK/CLK*	20	I/O	GPIO6, SD_CLK, SPICLK, HS1_CLK, U1CTS			
SDO/SD0*	21	I/O	GPIO7, SD_DATA0, SPIQ, HS1_DATA0, U2RTS			
SDI/SD1*	22	I/O	GPIO8, SD_DATA1, SPID, HS1_DATA1, U2CTS			
IO15 23 I/O		I/O	GPIO15, ADC2_CH3, TOUCH3, MTDO, HSPICS0, RTC_GPIO13, HS2_CMD, SD_CMD, EMAC_RXD3			
IO2 24 I/O		I/O	GPIO2, ADC2_CH2, TOUCH2, RTC_GPIO12, HSPIWP, HS2_DATA0, SD_DATA0			
IO0	25	I/O	GPIO0, ADC2_CH1, TOUCH1, RTC_GPIO11, CLK_OUT1, EMAC_TX_CLK			
104	26	I/O	GPIO4, ADC2_CH0, TOUCH0, RTC_GPIO10, HSPIHD, HS2_DATA1, SD_DATA1, EMAC_TX_ER			
IO16	27	I/O	GPIO16, HS1_DATA4, U2RXD, EMAC_CLK_OUT			
IO17	28	I/O	GPIO17, HS1_DATA5, U2TXD, EMAC_CLK_OUT_180			
IO5	29	1/0	GPIO5, VSPICSO, HS1_DATA6, EMAC_RX_CLK			
IO18	30	1/0	GPIO18, VSPICLK, HS1_DATA7			
IO19	31	I/O	GPIO19, VSPIQ, U0CTS, EMAC_TXD0			
NC	32	-	-			
IO21	33	I/O	GPIO21, VSPIHD, EMAC_TX_EN			
RXD0	34	I/O	GPIO3, U0RXD, CLK_OUT2			
TXD0	35	I/O	GPIO1, U0TXD, CLK_OUT3, EMAC_RXD2			
1022	36	I/O	GPIO22, VSPIWP, U0RTS, EMAC_TXD1			
IO23	37	I/O	GPIO23, VSPID, HS1_STROBE			
GND	38	Р	Ground			

Notice:

2.3 Strapping Pins

ESP32 has five strapping pins, which can be seen in Chapter 6 Schematics:

^{*} Pins SCK/CLK, SDO/SD0, SDI/SD1, SHD/SD2, SWP/SD3 and SCS/CMD, namely, GPIO6 to GPIO11 are connected to the integrated SPI flash integrated on the module and are not recommended for other uses.

- MTDI
- GPI00
- GPIO2
- MTDO
- GPI05

Software can read the values of these five bits from register "GPIO_STRAPPING".

During the chip's system reset (power-on-reset, RTC watchdog reset and brownout reset), the latches of the strapping pins sample the voltage level as strapping bits of "0" or "1", and hold these bits until the chip is powered down or shut down. The strapping bits configure the device's boot mode, the operating voltage of VDD_SDIO and other initial system settings.

Each strapping pin is connected to its internal pull-up/pull-down during the chip reset. Consequently, if a strapping pin is unconnected or the connected external circuit is high-impedance, the internal weak pull-up/pull-down will determine the default input level of the strapping pins.

To change the strapping bit values, users can apply the external pull-down/pull-up resistances, or use the host MCU's GPIOs to control the voltage level of these pins when powering on ESP32.

After reset, the strapping pins work as normal-function pins.

Refer to Table 3 for a detailed boot-mode configuration by strapping pins.

Table 3: Strapping Pins

Voltage of Internal LDO (VDD)

	Voltage of Internal LDO (VDD_SDIO)									
Pin	Default	3.0	3 V	1.8	3 V					
MTDI	Pull-down)	-	1					
			Booting Mode							
Pin	Default	SPI	Boot	Downlo	ad Boot					
GPIO0	Pull-up		1	()					
GPIO2	Pull-down	Don't-care 0								
	E	Enabling/Disabling Deb	ugging Log Print over l	JOTXD During Booting						
Pin	Default	UOTXE) Active	UOTXE) Silent					
MTDO	Pull-up		1	()					
			Timing of SDIO Slave							
Pin	Default	Falling-edge Input	Falling-edge Input	Rising-edge Input	Rising-edge Input					
ГШ	Delault	Falling-edge Output	Rising-edge Output	Falling-edge Output	Rising-edge Output					
MTDO	Pull-up	0 0 1 1			1					
GPIO5	Pull-up	0	1	0	1					

Note:

- Firmware can configure register bits to change the settings of "Voltage of Internal LDO (VDD_SDIO)" and "Timing of SDIO Slave" after booting.
- The module integrates a 3.3 V SPI flash, so the pin MTDI cannot be set to 1 when the module is powered up.

3. Functional Description

This chapter describes the modules and functions integrated in ESP32-SOLO-1C.

3.1 CPU and Internal Memory

ESP32-S0WD contains one low-power Xtensa® 32-bit LX6 microprocessor. The internal memory includes:

- 448 KB of ROM for booting and core functions.
- 520 KB of on-chip SRAM for data and instructions.
- 8 KB of SRAM in RTC, which is called RTC FAST Memory and can be used for data storage; it is accessed by the main CPU during RTC Boot from the Deep-sleep mode.
- 8 KB of SRAM in RTC, which is called RTC SLOW Memory and can be accessed by the co-processor during the Deep-sleep mode.
- 1 Kbit of eFuse: 256 bits are used for the system (MAC address and chip configuration) and the remaining 768 bits are reserved for customer applications, including flash-encryption and chip-ID.

3.2 External Flash and SRAM

ESP32 supports multiple external QSPI flash and SRAM chips. More details can be found in Chapter SPI in the

<u>ESP32 Technical Reference Manual</u>. ESP32 also supports hardware encryption/decryption based on AES to protect developers' programs and data in flash.

ESP32 can access the external QSPI flash and SRAM through high-speed caches.

- The external flash can be mapped into CPU instruction memory space and read-only memory space simultaneously.
 - When external flash is mapped into CPU instruction memory space, up to 11 MB + 248 KB can be mapped at a time. Note that if more than 3 MB + 248 KB are mapped, cache performance will be reduced due to speculative reads by the CPU.
 - When external flash is mapped into read-only data memory space, up to 4 MB can be mapped at a time. 8-bit, 16-bit and 32-bit reads are supported.
- External SRAM can be mapped into CPU data memory space. Up to 4 MB can be mapped at a time. 8-bit, 16-bit and 32-bit reads and writes are supported.

ESP32-SOLO-1C integrates 4 MB of external SPI flash. The 4-MB SPI flash can be memory-mapped onto the CPU code space, supporting 8, 16 and 32-bit access. Code execution is supported. The integrated SPI flash is connected to GPIO6, GPIO7, GPIO8, GPIO9, GPIO10 and GPIO11. These six pins cannot be used as regular GPIOs.

3.3 Crystal Oscillators

The module uses a 40-MHz crystal oscillator.

3.4 RTC and Low-Power Management

With the use of advanced power-management technologies, ESP32 can switch between different power modes

For details on ESP32's power consumption in different power modes, please refer to section "RTC and Low-Power Management" in *ESP32 Datasheet*.

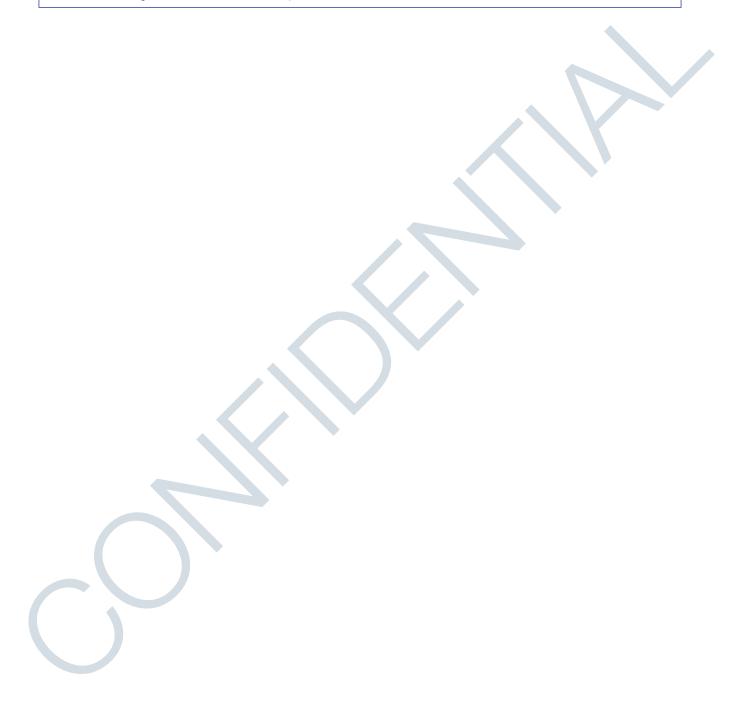


4. Peripherals and Sensors

Please refer to Section Peripherals and Sensors in *ESP32 Datasheet*.

Note:

External connections can be made to any GPIO except for GPIOs in the range 6-11. These six GPIOs are connected to the module's integrated SPI flash. For details, please see Section 6 Schematics.



5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Stresses beyond the absolute maximum ratings listed in the table below may cause permanent damage to the device. These are stress ratings only, and do not refer to the functional operation of the device.

Table 4: Absolute Maximum Ratings

Symbol	Parameter	Min	Max	Unit
VDD33	Power supply voltage	-0.3	3.6	V
T_{store}	Storage temperature	-40	150	°C
I_O^1	Cumulative IO output current	-	1,100	mA

- The module worked properly after a 24-hour test in ambient temperature at 25 °C, and the IOs in three domains (VDD3P3_RTC, VDD3P3_CPU, VDD_SDIO) output high logic level to ground. Please note that pins occupied by flash and/or PSRAM in the VDD_SDIO power domain were excluded from the test.
- 2. Please see Appendix IO_MUX of ESP32 Datasheet for IO's power domain.

5.2 Recommended Operating Conditions

Table 5: Recommended Operating Conditions

Symbol	Parameter	Min	Typical	Max	Unit
VDD33	Power supply voltage	2.7	3.3	3.6	V
$ \cdot _{VDD}$	Current delivered by external power supply	0.5	-	-	А
Т	Operating temperature	-40	-	85	°C

5.3 DC Characteristics (3.3 V, 25 °C)

Table 6: DC Characteristics (3.3 V, 25 °C)

Symbol	Par	Min	Тур	Max	Unit	
C_{IN}	Pin ca	-	2	-	рF	
V_{IH}	High-level	input voltage	0.75×VDD ¹	-	VDD ¹ +0.3	V
V_{IL}	Low-level	input voltage	-0.3	-	0.25×VDD ¹	V
$ I_{IH} $	High-level	-	-	50	nA	
$ I_{IL} $	Low-level	-	-	50	nA	
V_{OH}	High-level	0.8×VDD ¹	-	-	V	
V_{OL}	Low-level of	output voltage	-	-	0.1×VDD ¹	V
	High-level source current	VDD3P3_CPU power domain $^{1,\;2}$	-	40	-	mA
$ _{OH}$	$(VDD^1 = 3.3 \text{ V}, V_{OH} >= 2.64 \text{ V},$	VDD3P3_RTC power domain $^{1,\;2}$	-	40	-	mΑ
	PAD_DRIVER = 3)	VDD_SDIO power domain $^{1,\;3}$	-	20	-	mΑ
I_{OL}	Low-level sink current		_	28	_	mA
	$(VDD^1 = 3.3 \text{ V}, V_{OL} = 0.495 \text{ V}, PAD_DRIVER = 3)$			20		
R_{PU}	Pull-u	p resistor	-	45	-	kΩ

Symbol	Parameter		Тур	Max	Unit
R_{PD}	Pull-down resistor	-	45	-	kΩ
V_{IL_nRST}	Low-level input voltage of CHIP_PU to reset the chip	-	-	0.6	V

Notes:

- 1. Please see Appendix IO_MUX of <u>ESP32 Datasheet</u> for IO's power domain. VDD is the I/O voltage for a particular power domain of pins.
- 2. For VDD3P3_CPU and VDD3P3_RTC power domain, per-pin current sourced in the same domain is gradually reduced from around 40 mA to around 29 mA, $V_{OH}>=2.64$ V, as the number of current-source pins increases.
- 3. Pins occupied by flash and/or PSRAM in the VDD_SDIO power domain were excluded from the test.

5.4 Reflow Profile

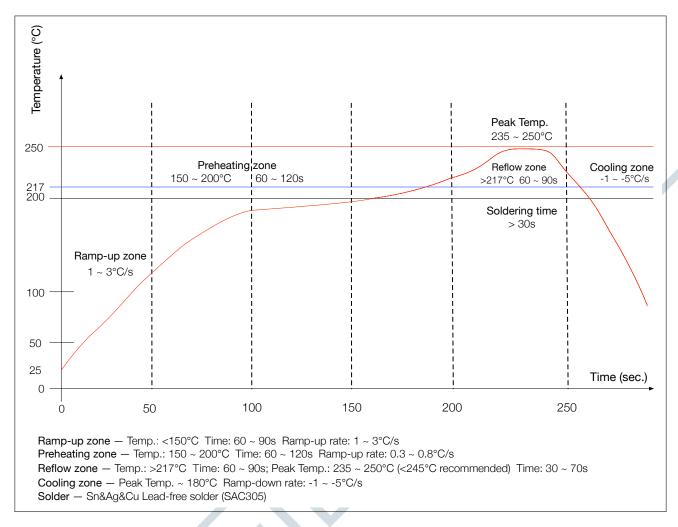
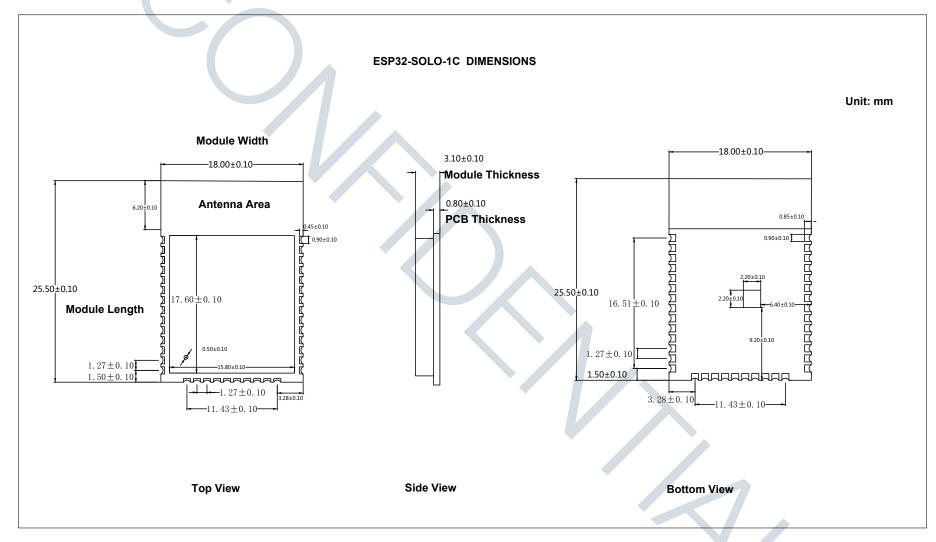


Figure 2: Reflow Profile

6. Physical Dimensions



Physical Dimensions

Figure 3: Physical Dimensions of ESP32-SOLO-1C

7. Recommended PCB Land Pattern

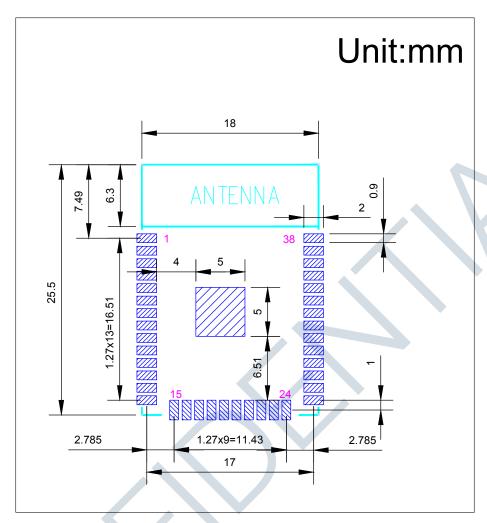


Figure4: Recommended PCB Land Pattern

Learning Resources 8.

8.1 **Must-Read Documents**

The following link provides documents related to ESP32.

• ESP32 Datasheet

This document provides an introduction to the specifications of the ESP32 hardware, including overview, pin definitions, functional description, peripheral interface, electrical characteristics, etc.

• ESP-IDF Programming Guide

It hosts extensive documentation for ESP-IDF ranging from hardware guides to API reference.

ESP32 Technical Reference Manual

The manual provides detailed information on how to use the ESP32 memory and peripherals.

• ESP32 Hardware Resources

The zip files include the schematics, PCB layout, Gerber and BOM list of ESP32 modules and development boards.

• ESP32 Hardware Design Guidelines

The guidelines outline recommended design practices when developing standalone or add-on systems based on the ESP32 series of products, including the ESP32 chip, the ESP32 modules and development boards.

• ESP32 AT Instruction Set and Examples

This document introduces the ESP32 AT commands, explains how to use them, and provides examples of several common AT commands.

Espressif Products Ordering Information

8 2 **Must-Have Resources**

Here are the ESP32-related must-have resources.

• ESP32 BBS

This is an Engineer-to-Engineer (E2E) Community for ESP32 where you can post questions, share knowledge, explore ideas, and help solve problems with fellow engineers.

ESP32 GitHub

ESP32 development projects are freely distributed under Espressif's MIT license on GitHub. It is established to help developers get started with ESP32 and foster innovation and the growth of general knowledge about the hardware and software surrounding ESP32 devices.

This is a webpage where users can download ESP32 Flash Download Tools and the zip file "ESP32 Certification and Test".

• ESP-IDF

This webpage links users to the official IoT development framework for ESP32.

ESP32 Resources

This webpage provides the links to all available ESP32 documents, SDK and tools.

Revision History

Date	Version	Release notes
2018.10	V0.1	Preliminary release.

FCC Statement

Any Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

FCC Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment .This equipment should be installed and operated with minimum distance 20cm between the radiator& your body.

FCC Label Instructions:

The outside of final products that contains this module device must display a label referring to the enclosed module. This exterior label can use wording such as: "Contains Transmitter Module FCC ID: 2AC7Z-ESP32SOLO1C", or "Contains FCC ID: 2AC7Z-ESP32SOLO1C", Any similar wording that expresses the same meaning may be used.